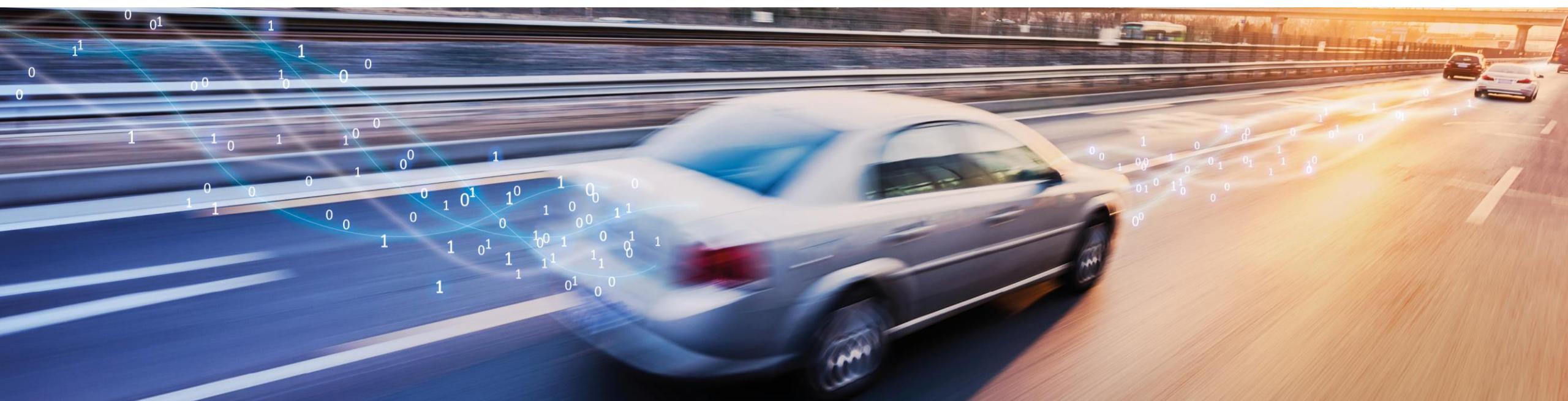


# ASAM CMP Capture Module Protocol

## Technical Seminar

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# Initial Situation

## Capture Module Protocol

### EE development of vehicles requires data recording

- In vehicle communication (LIN, CAN, FlexRay, xBaseT1)
- Sensor data (CAM, LiDAR, Radar)
- Debug data (DLT, ECU internal)
- Reference sensors

### Restrictions of actual systems (logger) for data collection

- Low scalability (number and type of Interfaces)
- TIER1 specific interfaces reduces reuse of loggers
- Simultaneously use of different TIER1 measurement in system test vehicle
- Centralized system with high impact on bus physics
- Implement new bus types in existing loggers not possible

# The Idea

## Capture Module Protocol

### Splitting the logging system

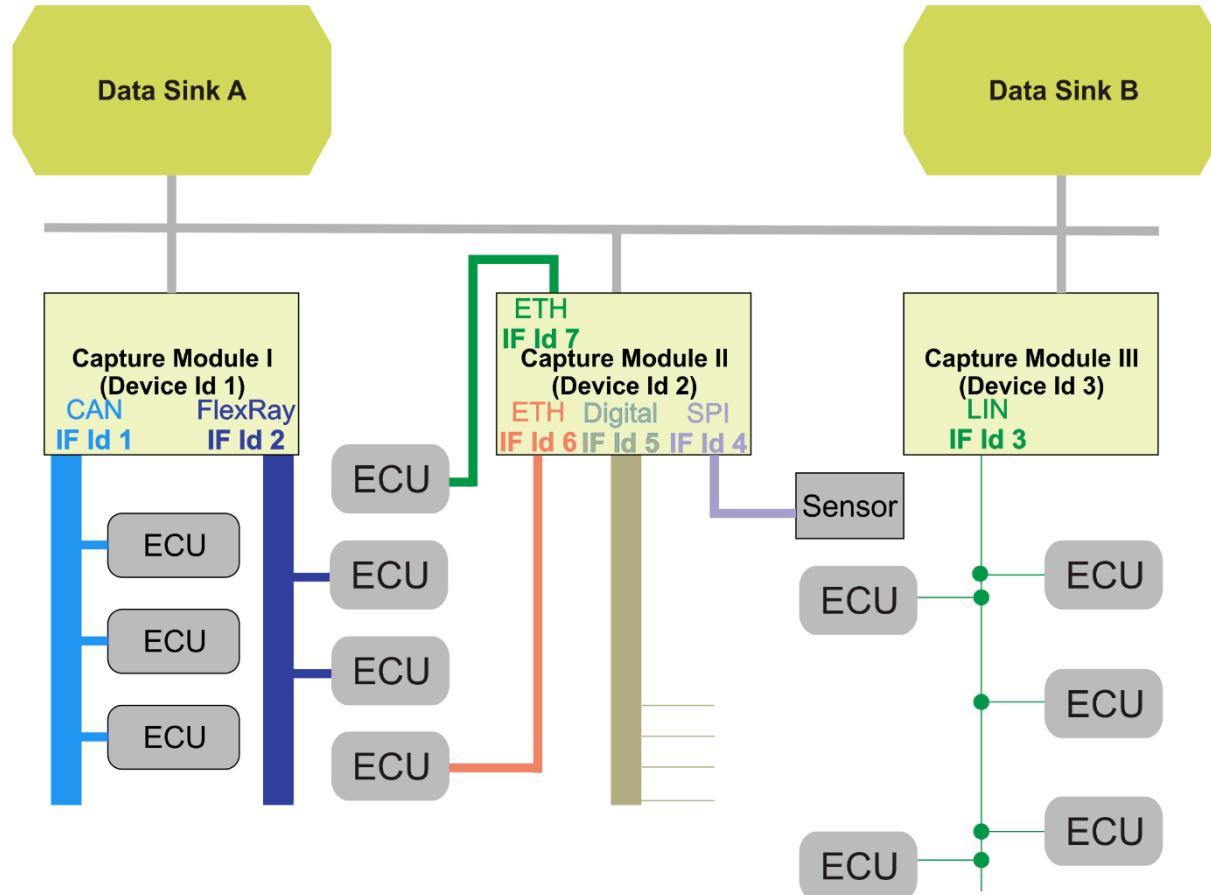
- small stand alone components
- Standardize data transport within the measurement network
  - Standardize translation of vehicle bus communication
  - Standardize TIER1 specific ECU/sensor data output

### UseCases

- Scalable measurement
- Reusability of components
- Segmentation of large data samples / Packaging of small data samples
- Timestamping
- Controlling
- Message-loss detection
- Scalable physical layer according to the required bandwidth

# System Overview

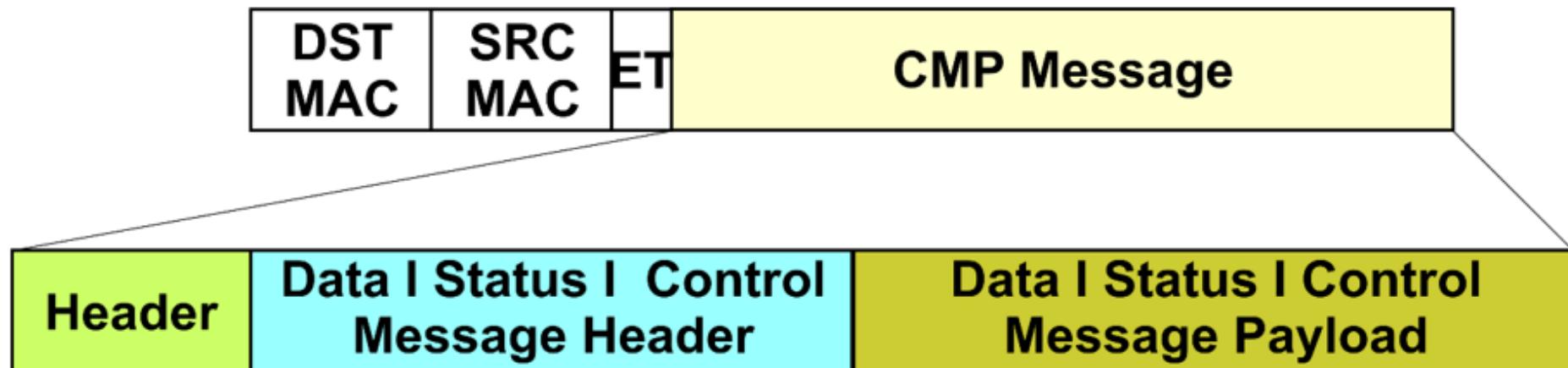
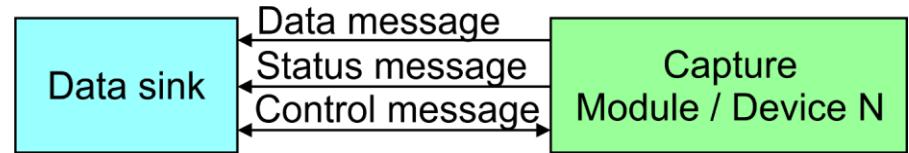
## Capture Module Protocol



# Protocol Basics

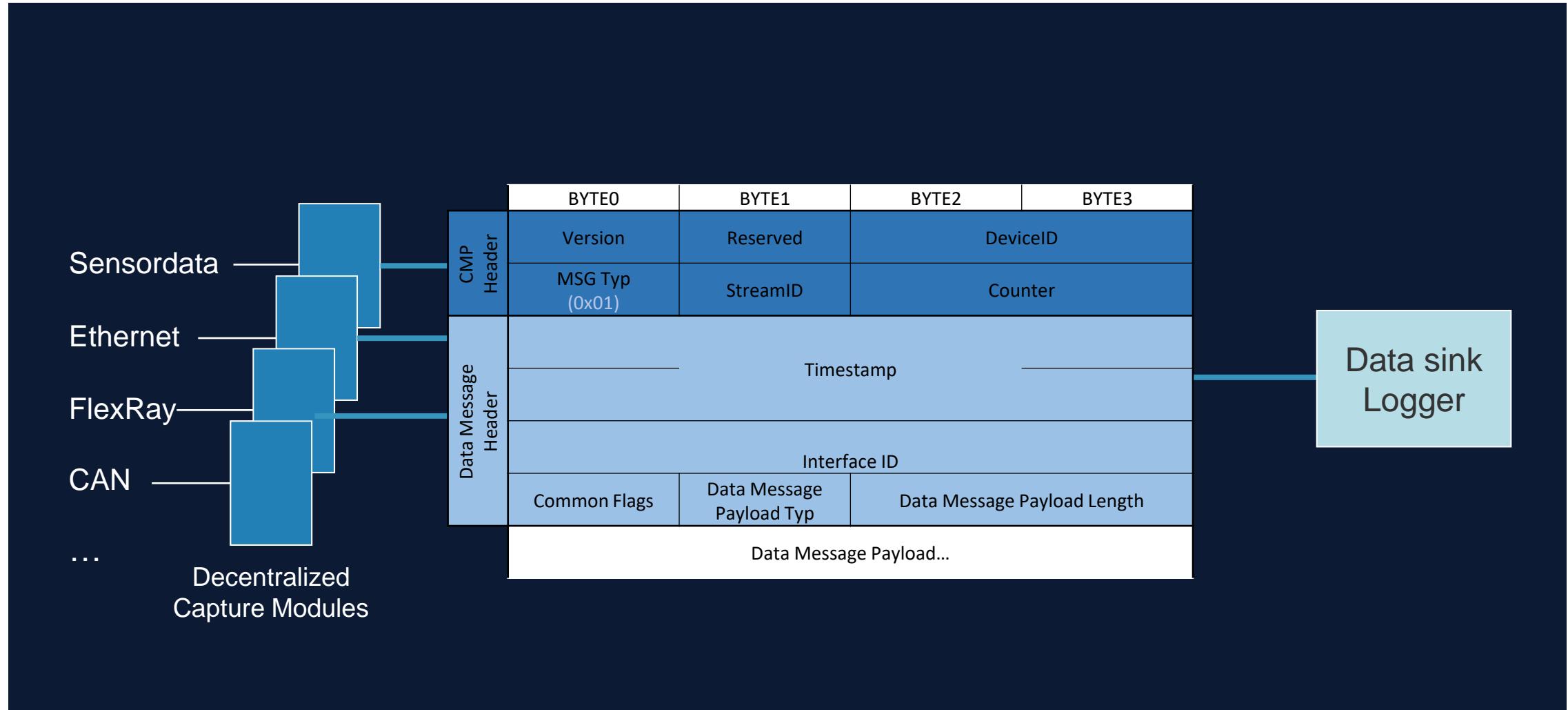
## Capture Module Protocol

- Transport based on Ethernet MAC Layer (EtherType 0x99FE)
- optionally also UDP
- Messages dedicated to streams
- Protocol for Time synchronization IEEE 802.1AS-2020
- Segmentation
- Packaging



# Example CMP Data Message

Capture Module Protocol

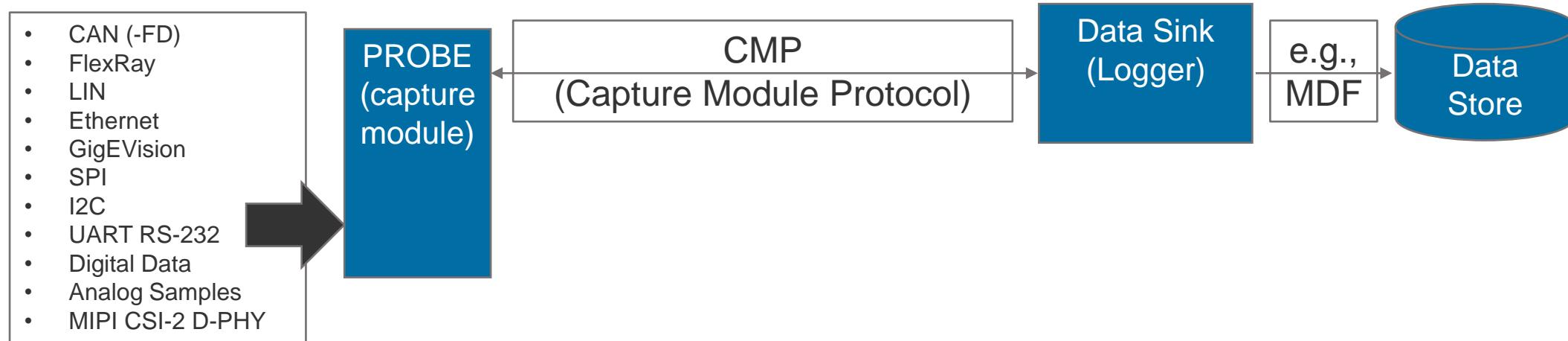


# Supported Data Message types

Capture Module Protocol

**There will be a variety of Capture Modules and Data sinks (e.g. Loggers) to be supported:**

- Ones that tap into the in-vehicle communication for layer-2 communication protocols (e.g., CAN, LIN, CAN-FD, FlexRay, Ethernet, etc)
- Ones that tap into the Interfaces for Lidar, Cameras, RADAR (e.g., MIPI CSI-2 D-PHY, GigEVision, SPI, I2C, etc.)
- Ones that tap into sensor busses for SPI, I2C, Digital



- In future versions of this standard the transport of further Bus-Systems may be added.

# Participants, Timeline, Prospect

## Capture Module Protocol

### Project Members

- Accurate Technologies
- Audi AG
- BMW AG
- ETAS GmbH
- Technica Engineering
- ViGEM GmbH

### Project Members

- AeD Engineering GmbH
- B-plus GmbH
- dSPACE GmbH
- RA Consulting GmbH
- Vector Informatik GmbH
- X2E GmbH

**The standard will be released in May 2022**

### Prospect

The new project start is planed for second half of year 2023 with the features

- Data replay
- Data compression
- Further Bus-Systems
- Further MIPI Image Data format

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